

c/ (Twice Amended) 15. A resistor array comprising:

a plurality of resistors each comprising a metallic bulk base;

5 a plurality of electrodes composed of conductive material
disposed directly on said metallic bulk base for connecting
each of said resistors to external circuits wherein said
metallic bulk base between every two of said electrodes
10 having a precisely controlled distance for providing a
precisely defined resistance for each of said resistors.

(Twice Amended) 16. The resistor array of claim 15 further
comprising:

15 at least an electrode layer of a different conductive material
disposed on each of said electrodes.

(Twice Amended) 17. The resistor array of claim 15 further
comprising:

20 a plurality of scribing lines disposed between said resistors
for scribing said resistor array into a plurality of resistors
each comprising at least two electrodes for connecting each
of said resistors to external circuits.

(Twice Amended) 18. The resistor array of claim 15 wherein:

25 said metallic bulk base comprising a nickel-copper alloy.

(Twice Amended) 19. The resistor array of claim 15 wherein:

30 each of said electrodes further comprises a copper layer and
a tin-lead alloy layer.

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(Twice Amended) 20. The resistor array of claim 15 wherein:

said precisely defined resistance for each of said resistors
ranging approximately from one milli-ohm to one ohm.

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(Twice Amended) 21. The resistor array of claim 15 wherein:

said metallic bulk base of each of said plurality of resistors
having a thickness ranging approximately from 0.05 to 0.5
millimeters and a length ranging approximately from 1.0 to
7.0 millimeters.

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(Twice Amended) 22. The resistor array of claim 15 wherein:

each of said plurality of electrodes disposed directly on said
metallic bulk base having a width and length ranging
approximately from 0.1 to 3.2 millimeter, a height ranging
approximately from 0.05 to 0.5 millimeters and distance
ranging approximately from 0.4 to 6.2 millimeters between
every two electrode columns.

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(Twice Amended) 23. A resistor array comprising:

a plurality of resistors each comprising a metallic bulk base;

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a plurality of column-shaped electroplated electrodes
disposed directly on said metallic bulk base for connecting
each of said resistors to external circuits and having a
precisely controlled distance between every two of said
electrodes for providing a precisely defined resistance for
each of said resistors.

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(Twice Amended) 24. The resistor array of claim 23 further comprising:

5 a plurality of scribing lines disposed between said resistors for scribing said resistor array into a plurality of resistors each comprising at least two electrodes for connecting each of said resistors to external circuits.

(Twice Amended) 25. The resistor array of claim 23 wherein:

10 said metallic bulk base comprising a nickel-copper alloy.

(Twice Amended) 26. The resistor array of claim 23 wherein:

15 each of said plurality of column-shaped electroplated electrodes disposed directly on said metallic bulk base further comprises a copper layer and a tin-lead alloy layer.

(Twice Amended) 27. The resistor array of claim 23 wherein:

20 said precisely defined resistance for each of said resistors ranging approximately from one milli-ohm to one ohm.

(Twice Amended) 28. The resistor array of claim 23 wherein:

25 said metallic bulk base of each of said plurality of resistors having a thickness ranging approximately from 0.05 to 0.5 millimeters and a length ranging approximately from 1.0 to 7.0 millimeters.

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(Twice Amended) 29. The resistor array of claim 23 wherein:

5 each of said plurality of column-shaped electrodes disposed directly on said metallic bulk base having a width and length ranging approximately from 0.1 to 3.2 millimeter, a height ranging approximately from 0.05 to 0.5 millimeters and distance ranging approximately from 0.4 to 6.2 millimeters between every two electrodes.

10 (Twice Amended) 30. A resistor comprising:

a metallic bulk base;

15 at least two electrodes composed of a conductive material disposed directly on said metallic bulk base for connecting said resistor to external circuits and having a precisely controlled distance between said two electrodes for providing a precisely defined resistance for said resistor.

20 (Twice Amended) 31. The resistor of claim 26 further comprising:

at least an electrode layer of a different conductive material disposed on each of said electrodes.

25 (Twice Amended) 32. The resistor of claim 30 wherein:

said metallic bulk base comprising a nickel-copper alloy.

(Twice Amended) 33. The resistor of claim 30 wherein:

30 each of said electrodes further comprises a copper layer and a tin-lead alloy layer.

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(Twice Amended) 34. The resistor of claim 30 wherein:

said precisely defined resistance for said resistor ranging
approximately from one milli-ohm to one ohm.

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(Twice Amended) 35. The resistor of claim 30 wherein:

said metallic bulk base of said resistor having a thickness
ranging approximately from 0.05 to 0.5 millimeters and a
length ranging approximately from 1.0 to 7.0 millimeters.

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(Twice Amended) 36. The resistor of claim 30 wherein:

each of said electrodes disposed directly on said metallic
bulk base having a width and length ranging approximately
from 0.1 to 3.2 millimeter, a height ranging approximately
from 0.05 to 0.5 millimeters and distance ranging
approximately from 0.4 to 6.2 millimeters between every two
electrode columns.

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(Twice Amended) 37. A resistor comprising:

a metallic bulk base;

a least two column-shaped electroplated electrodes disposed
directly on said metallic bulk base for connecting said
resistor to external circuits and having a precisely controlled
distance between said electrodes for providing a precisely
defined resistance for said resistor.

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(Twice Amended) 38. The resistor of claim 37 wherein:

said metallic bulk base comprising a nickel-copper alloy.

5 (Twice Amended) 39. The resistor of claim 37 wherein:

each of said column-shaped electroplated electrodes further comprises a copper layer and a tin-lead alloy layer.

10 (Twice Amended) 40. The resistor of claim 37 wherein:

said precisely defined resistance for said resistor ranging approximately from one milli-ohm to one ohm.

15 (Twice Amended) 41. The resistor of claim 37 wherein:

said metallic bulk base of said resistor having a thickness ranging approximately from 0.05 to 0.5 millimeters and a length ranging approximately from 1.0 to 7.0 millimeters.

20 (Twice Amended) 42. The resistor of claim 37 wherein:

25 each of said column-shaped electrodes disposed directly on said metallic bulk base having a width and length ranging approximately from 0.1 to 3.2 millimeter, a height ranging approximately from 0.05 to 0.5 millimeters and distance ranging approximately from 0.4 to 6.2 millimeters between every two electrodes.

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